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## MMBTA13

## **NPN Darlington Transistor**

- This device is designed for applications requiring extremely high Current gain at collector Currents to 1.0A.
- Sourced from process 05.
- See MPSA14 for characteristics.



1. Base 2. Emitter 3. Collector

## **Absolute Maximum Ratings** T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CES</sub>	Collector-Emitter Voltage	30	V	
$V_{CBO}$	Collector-Base Voltage	30	V	
$V_{EBO}$	Emitter-Base Voltage	10	V	
I <sub>C</sub>	Collector Current - Continuous	1.2	A	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C	

## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units	
Off Charact	Off Characteristics					
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	$I_C = 100\mu A, I_B = 0$	30		V	
I <sub>CBO</sub>	Collector-Cutoff Current	$V_{CB} = 30V, I_E = 0$		100	nA	
I <sub>EBO</sub>	Emitter-Cutoff Current	V <sub>EB</sub> = 10V, I <sub>C</sub> = 0		100	nA	
On Characteristics *						
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 5.0V, I_{C} = 10mA$ $V_{CE} = 5.0, I_{C} = 100mA$	5,000 10,000			
V <sub>CE (sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 100mA, I <sub>B</sub> = 0.1mA		1.5	V	
V <sub>BE (on)</sub>	Base-Emitter On Voltage	$I_C = 100 \text{mA}, V_{CE} = 5.0 \text{V}$		2.0	V	
Small Signal Characteristics						
f <sub>T</sub>	Current Gain Bandwidth Product	$I_C = 10 \text{mA}, V_{CE} = 10 \text{V}, f = 100 \text{MHz}$	125		pF	

<sup>\*</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

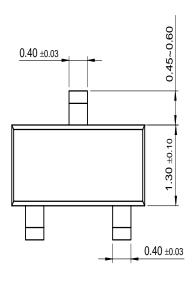
# Thermal Characteristics $T_a$ =25°C unless otherwise noted

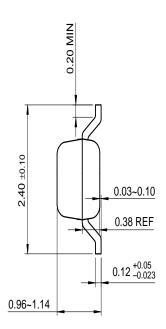
Symbol	Parameter	Max.	Units
$P_{D}$	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

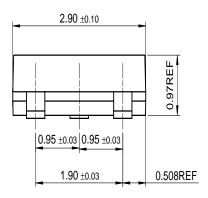
<sup>\*</sup> Device mounted on FR-4PCB 1.6"  $\times$  1.6"  $\times$  0.06".

## **Mechanical Dimensions**

# SOT-23







Dimensions in Millimeters

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